# BAS21AHT1G

Preferred Device

# Low Leakage **Switching Diode**

#### Features

• This is a Pb-Free Device

#### MAXIMUM RATINGS

Symbol	Rating	Value	Unit
V <sub>R</sub>	Continuous Reverse Voltage	250	Vdc
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	250	Vdc
١ <sub>F</sub>	Peak Forward Current	200	mAdc
I <sub>FM(surge)</sub>	Peak Forward Surge Current	625	mAdc

#### **THERMAL CHARACTERISTICS**

Symbol	Characteristic	Max	Unit	
PD	Total Device Dissipation FR-5 Board, (Note 1) $T_A = 25^{\circ}C$	200	mW	
	Derate above 25°C	1.57	mW/°C	
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient	635	°C/W	
T <sub>J</sub> , T <sub>stg</sub>	Junction and Storage Temperature Range	-55 to +150	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 Minimum Pad

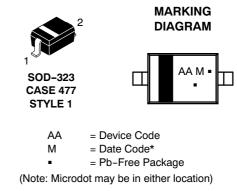


## **ON Semiconductor®**

http://onsemi.com

# LOW LEAKAGE SWITCHING DIODE

10 **-0** 2 CATHODE ANODE



\*Date Code orientation may vary depending upon manufacturing location.

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
BAS21AHT1G	SOD-323 (Pb-Free)	3000/Tape & Reel

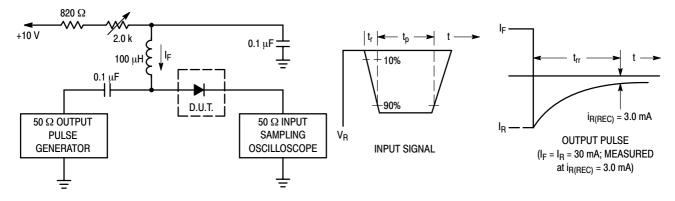
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

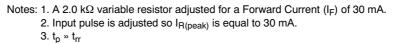
Preferred devices are recommended choices for future use and best overall value.

# BAS21AHT1G

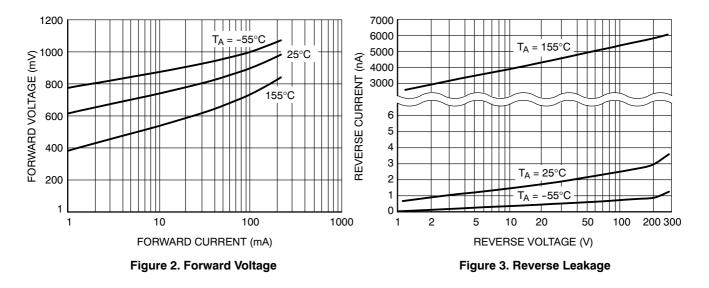
### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Reverse Voltage Leakage Current ( $V_R = 200 \text{ Vdc}$ ) ( $V_R = 200 \text{ Vdc}$ , $T_J = 150^{\circ}\text{C}$ )	Ι <sub>R</sub>			40 100	nAdc μAdc
Reverse Breakdown Voltage (I <sub>BR</sub> = 100 μAdc)	V <sub>(BR)</sub>	250	-	-	Vdc
Forward Voltage (I <sub>F</sub> = 100 mAdc) (I <sub>F</sub> = 200 mAdc)	V <sub>F</sub>		- -	1000 1250	mV
Diode Capacitance (V <sub>R</sub> = 0, f = 1.0 MHz)	C <sub>D</sub>	-	-	5.0	pF
Reverse Recovery Time ( $I_F = I_R = 30 \text{ mAdc}, R_L = 100 \Omega$ )	t <sub>rr</sub>	-	50	-	ns





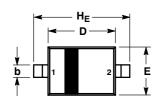
## Figure 1. Recovery Time Equivalent Test Circuit

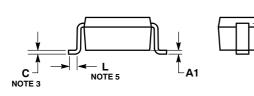


## BAS21AHT1G

#### PACKAGE DIMENSIONS

SOD-323 PLASTIC PACKAGE CASE 477-02 ISSUE H





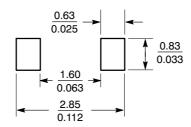
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
- 4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 5. DIMENSION L IS MEASURED FROM END OF RADIUS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.90	1.00	0.031	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.15 REF			0.006 REF		
b	0.25	0.32	0.4	0.010	0.012	0.016
С	0.089	0.12	0.177	0.003	0.005	0.007
D	1.60	1.70	1.80	0.062	0.066	0.070
E	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
HE	2.30	2.50	2.70	0.090	0.098	0.105

STYLE 1: PIN 1. CATHODE 2 ANODE

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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